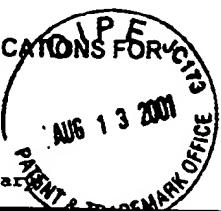


FORM PTO-1449 (Modified)

LIST OF PATENTS AND PUBLICATIONS FOR CITE  
APPLICANT'S INFORMATION  
DISCLOSURE STATEMENT

(Use several sheets if necessary)

ATTY. DOCKER

FIS9-2000-0412-US1

SERIAL NO.

09/870,531

D. J. Darrow  
9-4-01

APPLICANT: Brofman et al.

FILING DATE: 05/31/01

GROUP: 2815 2813

## REFERENCE DESIGNATION

## U.S. PATENT DOCUMENTS

EXAMINER INITIALS	DOCUMENT NUMBER	ISSUED DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPRO.)
<i>JMM</i>	AA 5,258,236	11/02/93	Arjavalingam et al.	428	626	—
	AB 5,497,545	03/12/96	Watanabe et al.	29	830	—
	AC 5,654,590	08/05/97	Kuramochi	257	778	—
	AD 5,965,933	10/12/99	Young et al.	257	621	—
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	AF 6,066,562	05/23/00	Oshima et al.	438	691	—
	AG 6,184,060	02/06/01	Siniaguine	438	106	—
<i>JMM</i>	AH 6,187,418	02/13/01	Fasano et al.	428	210	—

## FOREIGN PATENT DOCUMENTS

EXAMINER	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
AI							

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

<i>JMM</i>	AK	Matsuo et al. "Silicon Interposer Technology for High-density Package", Session 36, Afternoon, Wednesday, May 24, 2000, at Caesar's Palace, Las Vegas, NV, Proceedings of IEEE Electronic Components and Technology Conference, IEEE, ISBN 0780359089, 4 pages, 2000
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EXAMINER

DATE CONSIDERED

11/10/04

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.